

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

JT9626-AS

LSI for LCD Watches

This product is a single-chip CMOS LSI for watches with alarm and chronograph functions. It can directly drive a six-digit LCD and offers six functions.

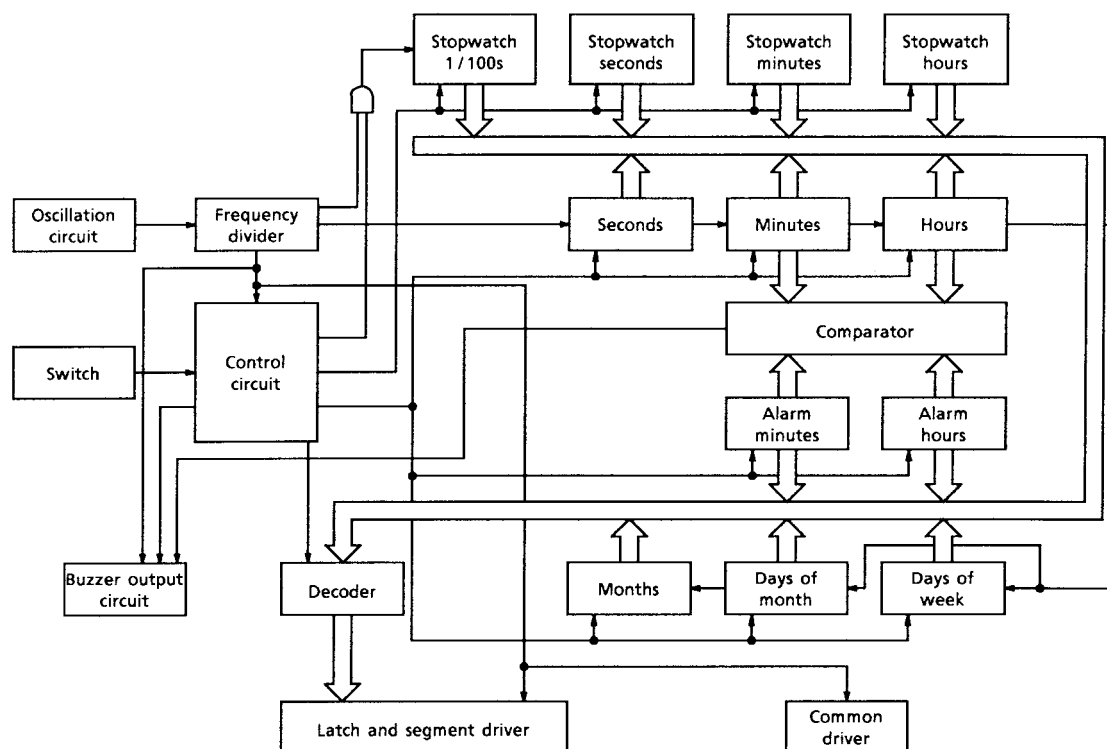
Applications

- Watches with alarms and chronographs
- Watches with alarms
- Chronograph watches

Features

- Alarm function with buzzer drive
- Chronograph function with lap recording
- Time signal function
- Display switchable between 12-hour system, or 24-hour system
- Six-digit display, 10 signs, 1/2-duty LCD drive
- Second, minute, hour, day of month, day of week, month recording function. Four-year auto-calendar function
- Chronograph has 1/100 second, second, minute, and hour counter (1/100 second for up to 30 minutes). Counting up to 24 hours with lap function and confirmation buzzer sound
- Directly drives buzzer for alarm and time signal (4 kHz)
- Low current consumption
- Selectable 1.55 V single power supply/3.00 V single power supply by bonding
- Three-switch operation
- Built-in voltage doubler/halver circuits
- All display lit function for testing
- Built-in power ON clear function
- Alarm settable in one-minute units (buzzer sounds for 20 seconds)

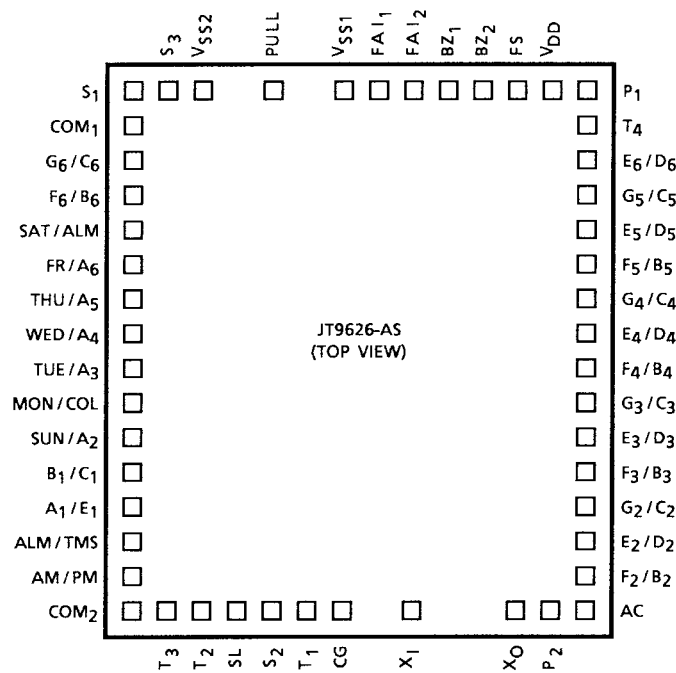
Block Diagram



Pin Descriptions (51 pins)

Pin Name	Symbol	No. of Pins
Power Supply Pins	V _{DD} , V _{SS1} , V _{SS2} , PULL	4
Oscillator Pins	X _I , X _O , C _G	3
Input Pins	S ₁₋₃ , SL, P ₁ , P ₂ , AC, FS	8
Output Pins	BZ1, BZ2	2
Display Pins	COM ₁ , COM ₂ , SEG (26)	28
Test Pins	T ₁₋₄	4
Voltage Doubler/Halver Pins	FAI ₁ , FAI ₂ (256 Hz, d.f = 50%)	2

Pad Layout



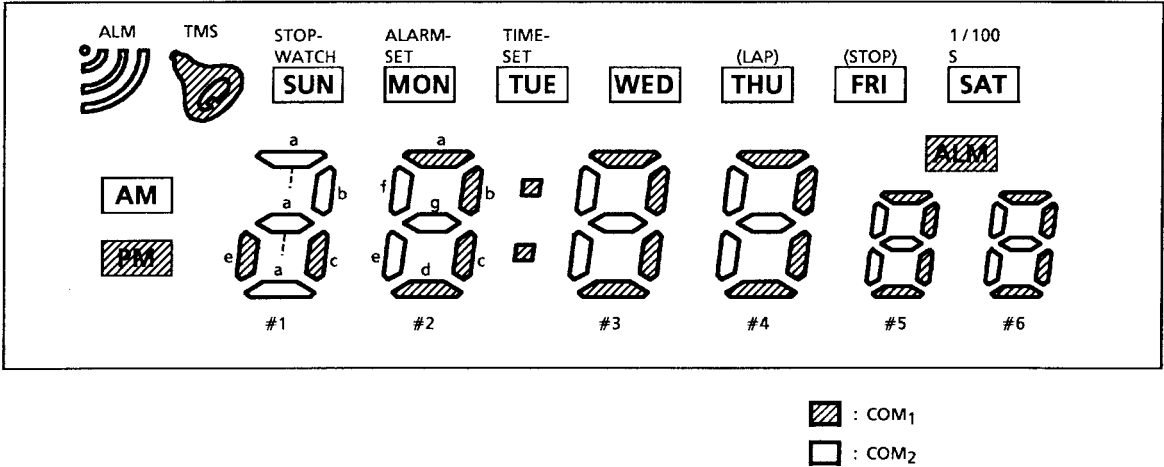
Chip size : 2.70×2.75 (mm)
Chip thickness : 300±30 (μm)

Pad Location Table

Pin Name	X Point	Y Point	Pin Name	X Point	Y Point
P ₁	1211	1232	COM ₂	1211	-1221
T ₄	1211	1058	AM/PM	1211	-1058
E ₆ /D ₆	1211	895	ALM/TMS	1211	-895
G ₅ /C ₅	1211	733	A ₁ /E ₁	1211	-733
E ₅ /D ₅	1211	570	B ₁ /C ₁	1211	-570
F ₅ /B ₅	1211	407	SUN/A ₂	1211	-407
G ₄ /C ₄	1211	244	MON/COL	1211	-244
E ₄ /D ₄	1211	81	TUE/A ₃	1211	-81
F ₄ /B ₄	1211	-81	WED/A ₄	1211	81
G ₃ /C ₃	1211	-244	THD/A ₅	1211	244
E ₃ /D ₃	1211	-407	FRI/A ₆	1211	407
F ₃ /B ₃	1211	-570	SAT/ALM	1211	570
G ₂ /C ₂	1211	-733	F ₆ /B ₆	1211	733
E ₂ /D ₂	1211	-895	G ₆ /C ₆	1211	895
F ₂ /B ₂	1211	-1058	COM ₁	1211	1058
AC	1211	-1232	S ₁	1211	1232
P ₂	982	-1236	S ₃	-982	1236
X _O	819	-1236	V _{SS2}	-819	1236
X _I	335	-1236	PULL	-445	1236
C _G	-20	-1236	V _{SS1}	-158	1236
T ₁	-183	-1236	FAI ₁	5	1236
S ₂	-420	-1236	FAI ₂	242	1236
SL	-582	-1236	BZ ₁	405	1236
T ₂	-819	-1236	BZ ₂	642	1236
T ₃	-982	-1236	FS	804	1236
			V _{DD}	1021	1236

Function Specifications

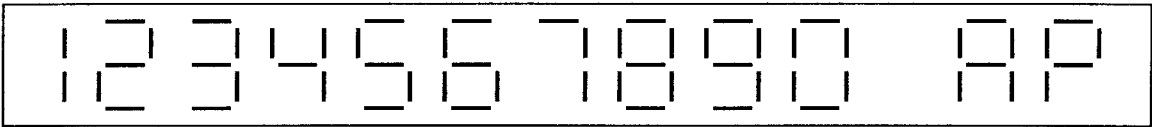
1. LCD Layout



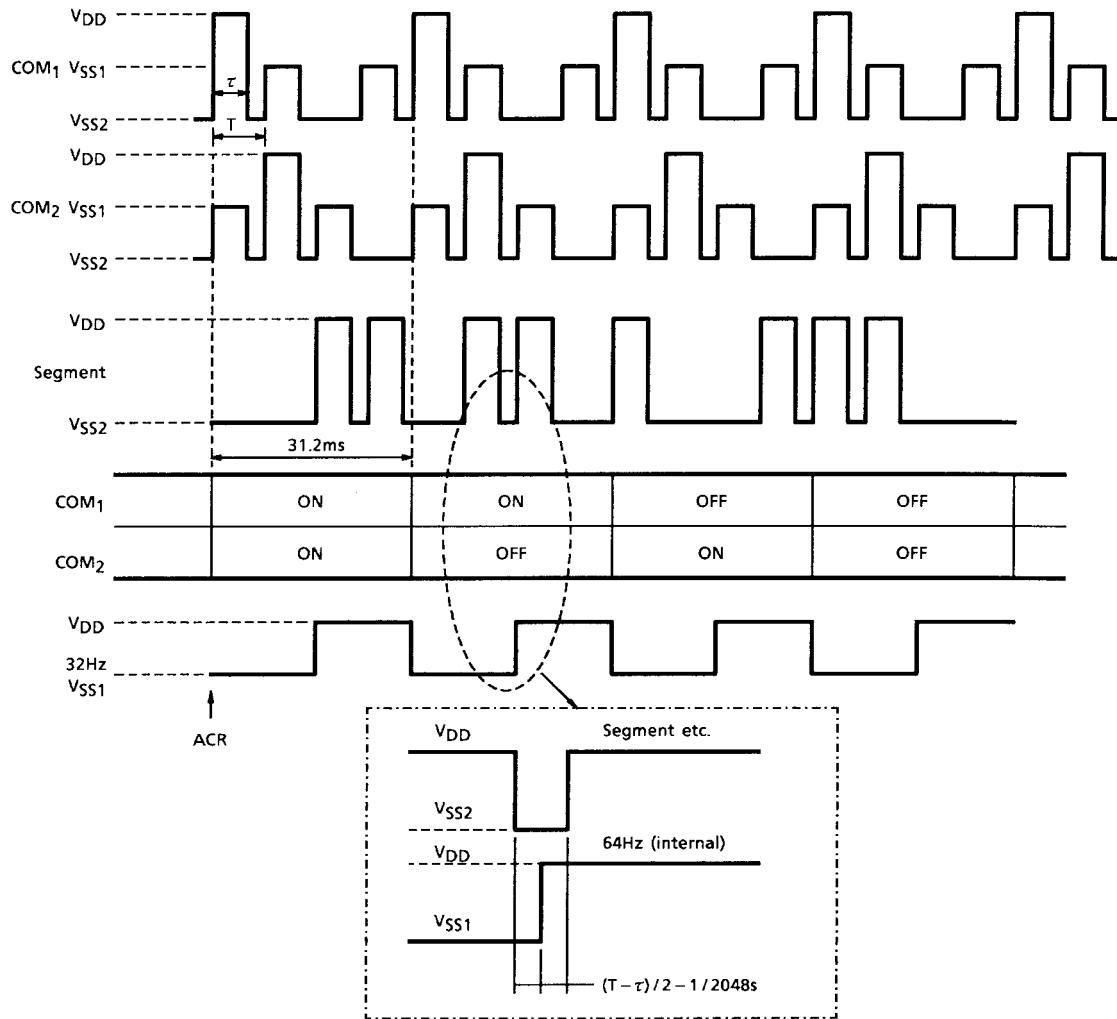
Pad Name	COM ₁	COM ₂	Pad Name	COM ₁	COM ₂
2F/2B	2F	2B	AM/PM	AM	PM
2E/2D	2E	2D	ALM/TMS	ALM	TMS
2G/2C	2G	2C	1A/1E	1A	1E
3F/3B	3F	3B	1B/1C	1B	1C
3E/3D	3E	3D	SUN/2A	SUN	2A
3G/3C	3G	3C	MON/COL	MON	COL
4F/4B	4F	4B	TUE/3A	TUE	3A
4E/4D	4E	4D	WED/4A	WED	4A
4G/4C	4G	4C	THU/5A	THU	5A
5F/5B	5F	5B	FRI/6A	FRI	6A
5E/5D	5E	5D	SAT/ALM	SAT	ALM
5G/5C	5G	5C	6F/6B	6F	6B
6E/6D	6E	6D	6G/6C	6G	6C

Note 1: This LSI has two pads for alarm sign. Both pads indicate same state. Use the preferred sign. Delete the other sign from the LCD.

2. Display Example



3. LCD Drive Waveform



$$T = 1/128 \text{ s}$$

$$\tau = 7/1024 \text{ s}$$

4. Function Selection Specifications

The JT9626-AS uses P1 and P2 to disable either the chronograph function or the alarm function. Normally, P1 and P2 are pulled up to VDD level. Select according to the table below.










P ₁	H (OPEN)	With CHRONOGRAPH mode
	L (V _{SS1} or V _{SS2})	No CHRONOGRAPH mode
P ₂	H (OPEN)	With ALARM mode
	L (V _{SS1} or V _{SS2})	No ALARM mode

5. Control Input Specifications

The JT9626-AS is controlled by three switches: S₁, S₂, and S₃.

This control includes both simultaneous pressing, and depressing for two seconds.

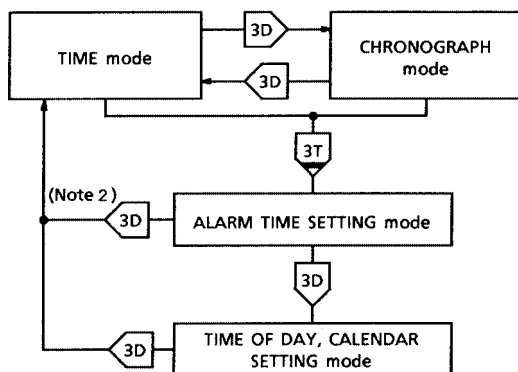
The symbols used are shown in the following table.

Symbol	Operation
  	S ₁ , S ₂ , or S ₃ momentary press
  	S ₁ , S ₂ , or S ₃ released
  	S ₁ , S ₂ , or S ₃ depressed two seconds

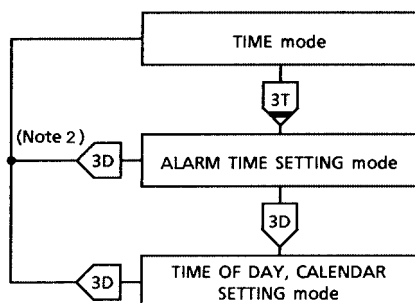
6. Switching Function

Selecting the bonding option

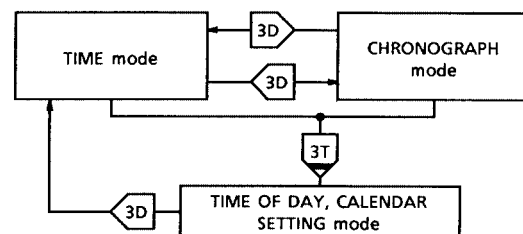
Watch with alarm and chronograph (P₁, P₂ open)



Watch with alarm (P₁ = V_{SS})



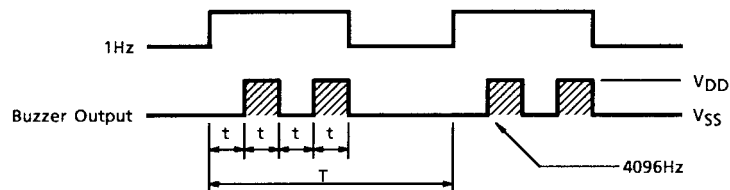
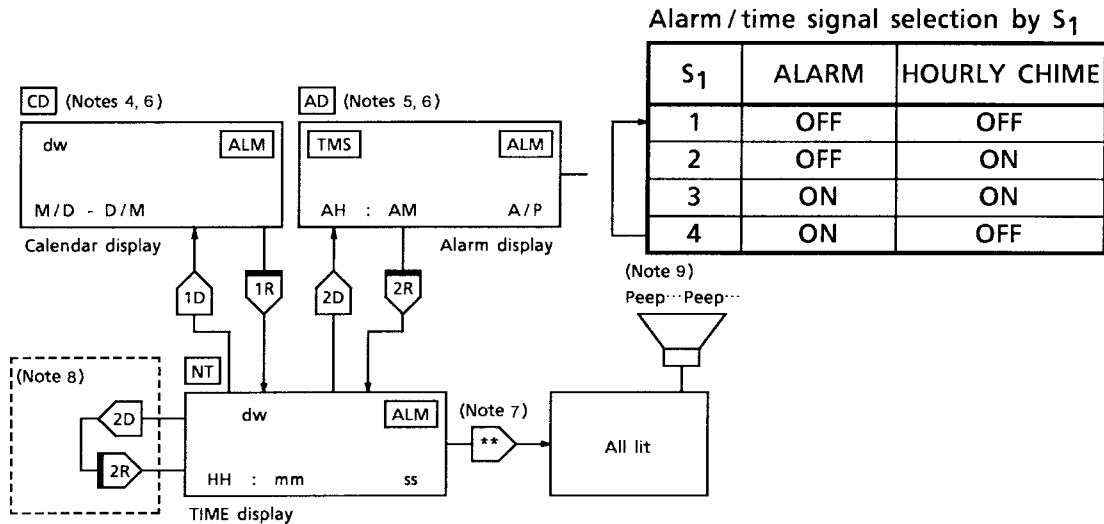
Watch with chronograph (P₂ = V_{SS})



Note 2: If you press S₃ after using either S₁ or S₂ in alarm time setting mode, the system returns to the time mode.

Note 3: Most display switching functions can be performed by pressing S₃ momentarily.

Basic Switch Operation

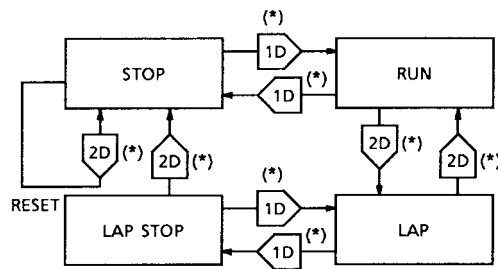


$$T = 1 \text{ [s]}$$

$$t = 0.125 \text{ [s]}$$

7. Chronograph Function

In CHRONOGRAPH mode, pressing S1 switches between RUN/STOP. Pressing S2 switches between LAP/LAP RELEASE. In STOP and LAP RELEASE states, pressing S2 performs a reset. The flow is as follows.

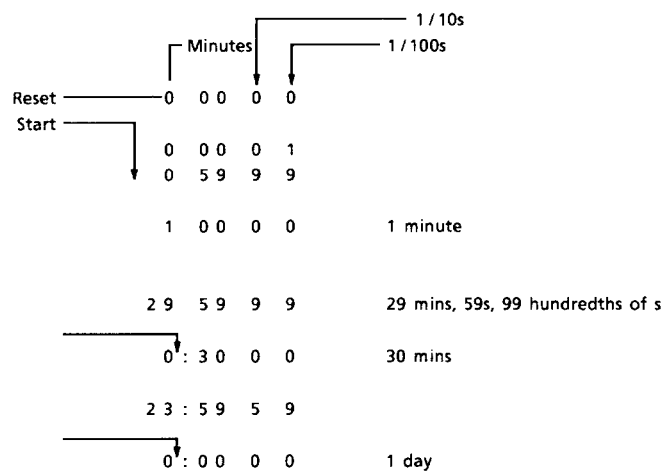


Note 10: All day of the week marks are lit, with the relevant mark blinking at 2 Hz depending on state. When the LAP display or the LAP STOP display are selected, the LAP sign flashes at 2 Hz and shows the lap time.

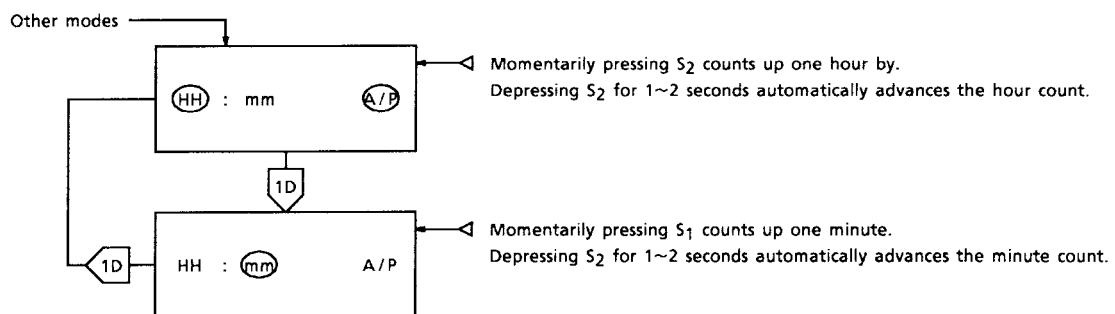
When the STOP display or the LAP STOP display are selected, the STOP sign flashes at 2 Hz to show that clocking has stopped.

Note 11: During 1/100 second display, the 1/100 second mark continues blinking at 2 Hz until the count reaches 30 minutes.

Note 12: Chronograph display flow



8. Alarm Set Function



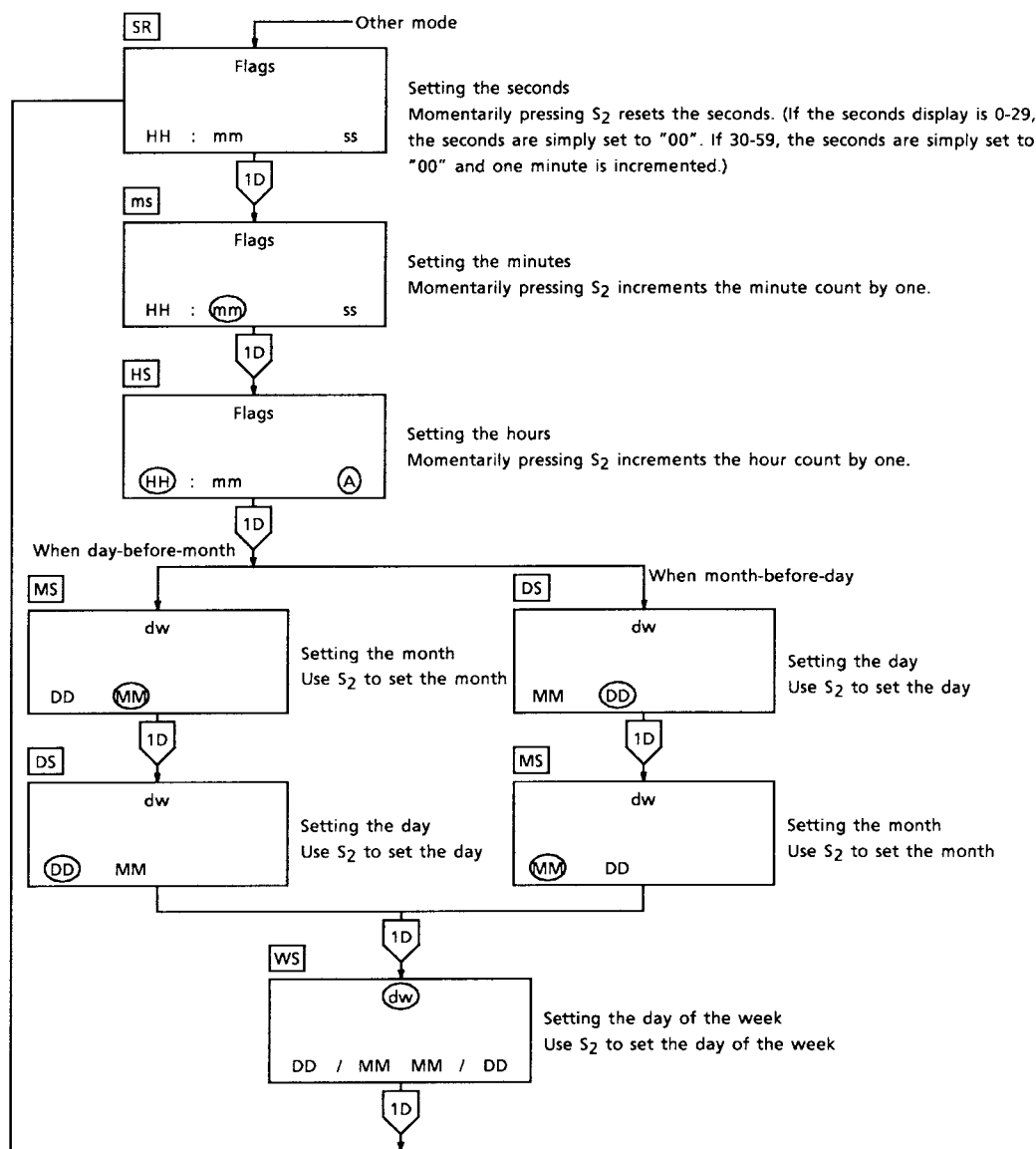
Note 13: To distinguish between AM and PM, an "A" or a "P" can be displayed in the seconds column. The same is available for the 24-hour SYSTEM.

Note 14: When the alarm time is set, the alarm is automatically set.

Note 15: In TIME mode, pressing S2 while the alarm is sounding stops the alarm.

9. Time/Calendar Setting Function

The following shows the flow when S₁ is momentarily pressed in TIME/CALENDAR SETTING mode.



Note 16: In all setting states except for second reset, holding down S₂ automatically advances the count.

10. All Clear Function

When power is applied or when the supply of power is interrupted (e.g. if the battery is changed), the internal state of the IC may become unstable, even though it appears to be operating normally. For this reason it is vital to verify that the crystal oscillation circuit is oscillating normally and stably (at 32 kHz) and then to use the system reset pin to initialize the IC (i.e. clear it) before use.

Note that a clear operation using the built-in power-on clear circuit should not be used in this case.

Maximum Ratings

Characteristics	Symbol	Rating	Unit
Power supply voltage (1)	$V_{SS1}-V_{DD}$	-3.0~0.2	V
Power supply voltage (2)	$V_{SS2}-V_{DD}$	-6.0~0.2	V
Operating temperature	T_{opr}	-10~60	°C
Storage temperature	T_{stg}	-40~125	°C

Electrical Characteristics

(unless otherwise stated, $V_{DD} = 0$ V, $V_{SS1} = -1.55$ V, $V_{SS2} = -3.0$ V, $T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Operating voltage (1)	$V_{SS1}-V_{DD}$	1	—	1.25	1.55	2.00	V
Operating voltage (2)	$V_{SS2}-V_{DD}$	1	—	2.00	3.00	4.00	V
Output current (1) (COM)	I_{OH1}	—	$V_{SS2} = -3.0$ V	$V_{OH1} = -0.3$ V	—	-70	μA
	I_{OL1}			$V_{OL1} = -2.7$ V	70	—	
Output current (2) (segment)	I_{OH2}	—	$V_{SS2} = -3.0$ V	$V_{OH2} = -0.3$ V	—	-6.0	μA
	I_{OL2}			$V_{OL2} = -2.7$ V	6.0	—	
C_D	C_{OUT}	—	—	—	16	—	pF

Silver Oxide Type (-1.55 V)

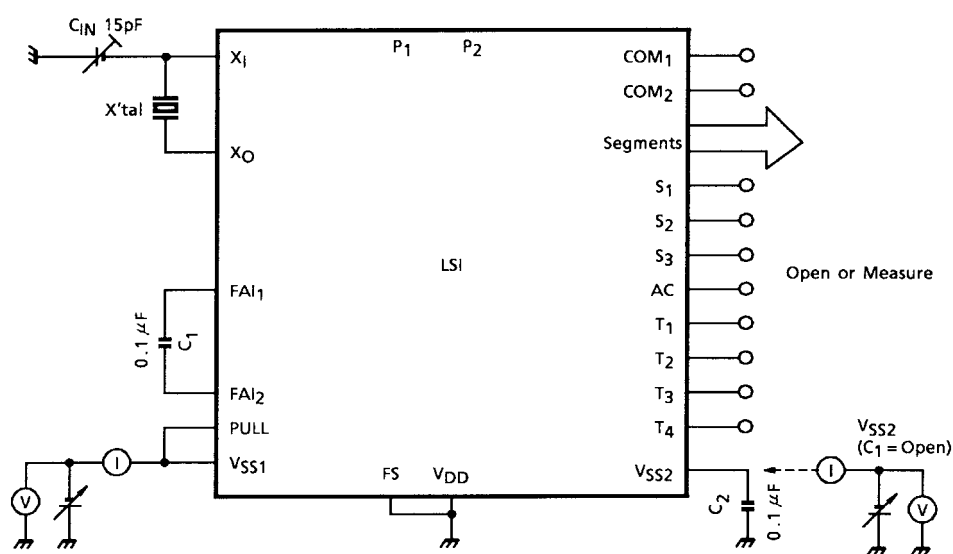
Characteristics	Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Dissipation current (1)	$ I_{sup1} $	1	—	—	1.5	2.5	μA
Oscillation start voltage (1)	$ V_{STA1} $	1	—	—	—	1.45	V
Output current (3) (BZ ₁ , BZ ₂)	I_{OH3}	—	$V_{SS1} = -1.25$ V	$V_{OH3} = -0.5$ V	—	-200	μA
	I_{OL3}		$V_{SS2} = -0.75$ V	$V_{OL3} = -0.75$ V	200	—	
Input current (1) (S ₁ ~3)	I_{IH1}	—	$V_{SS1} = -0.55$ V	$V_{IH1} = 0$ V	0.3	4.4	μA
	I_{IL1}			$V_{IL1} = -1.55$ V	-0.10	—	
Input current (2) (T ₁ ~4)	I_{IH2}	—	$V_{IH2} = 0$ V	—	—	0.1	μA
	I_{IL2}	—	$V_{IL2} = -1.55$ V	-155	—	-10.0	
Input current (3) (P ₁ , P ₂)	I_{IH3}	—	$V_{IH3} = 0$ V, $T_4 = V_{SS1}$	—	—	0.1	μA
	I_{IL3}	—	$V_{IL3} = -1.55$ V, $T_4 = V_{SS1}$	-2.0	—	-0.1	
Input current (4) (AC)	I_{IH4}	—	$V_{IH4} = 0$ V	10.0	—	155.0	μA
	I_{IL4}	—	$V_{IL4} = -1.55$ V	-0.1	—	—	

Lithium Type (–3.0 V)

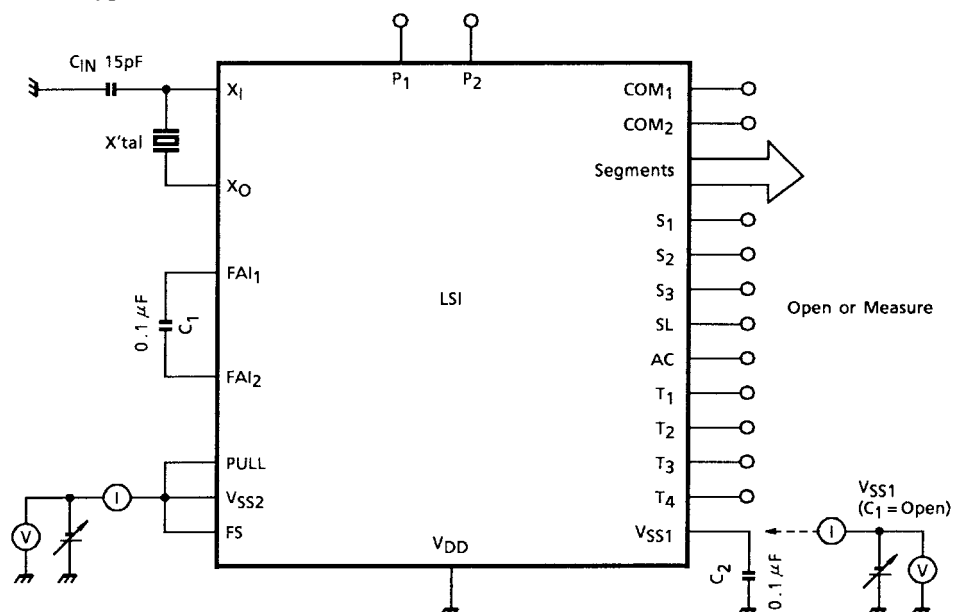
Characteristics	Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Dissipation current (2)	$ I_{\text{sup2}} $	2	—	—	1.00	1.50	μA
Oscillation start voltage (2)	$ V_{\text{STA2}} $	2	—	—	—	2.40	V
Output current (4) (BZ ₁ , BZ ₂)	I_{OH4}	—	$V_{\text{SS1}} = -1.25 \text{ V}$ $V_{\text{OH4}} = -0.5 \text{ V}$	—	—	–200	μA
	I_{OL4}		$V_{\text{SS2}} = -2.00 \text{ V}$ $V_{\text{OL4}} = -0.75 \text{ V}$	200	—	—	
Input current (5) (S ₁ –3, SL)	I_{IH5}	—	$V_{\text{IH5}} = 0 \text{ V}$	5.0	—	18.0	μA
	I_{IL5}	—	$V_{\text{IL5}} = -3.00 \text{ V}$	–0.10	—	—	
Input current (6) (T ₁ –4)	I_{IH6}	—	$V_{\text{IH6}} = 0 \text{ V}$	—	—	0.1	μA
	I_{IL6}	—	$V_{\text{IL6}} = -3.00 \text{ V}$	–300	—	–7.5	
Input current (7) (P ₁ , P ₂)	I_{IH7}	—	$V_{\text{IH7}} = 0 \text{ V}, T_4 = V_{\text{SS2}}$	—	—	0.1	μA
	I_{IL7}	—	$V_{\text{IL7}} = -3.00 \text{ V}, T_4 = V_{\text{SS2}}$	–2.0	—	–0.10	
Input current (8) (AC)	I_{IH8}	—	$V_{\text{IH8}} = 0 \text{ V}$	7.5	—	300	μA
	I_{IL8}	—	$V_{\text{IL8}} = -3.00 \text{ V}$	–0.10	—	—	

Test Circuit

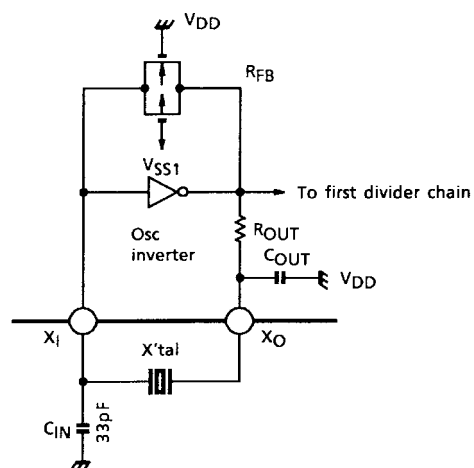
(1) Silver oxide type (–1.55 V)



(3)



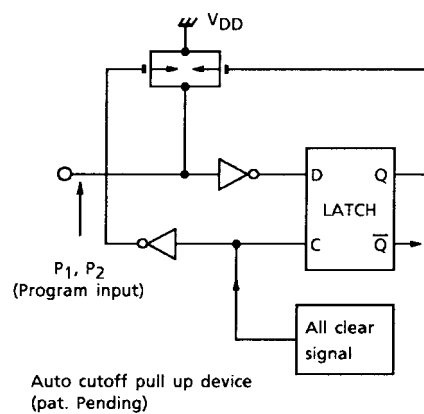
(3)



$$f_{\text{osc}} = 32.768 \text{ kHz}$$

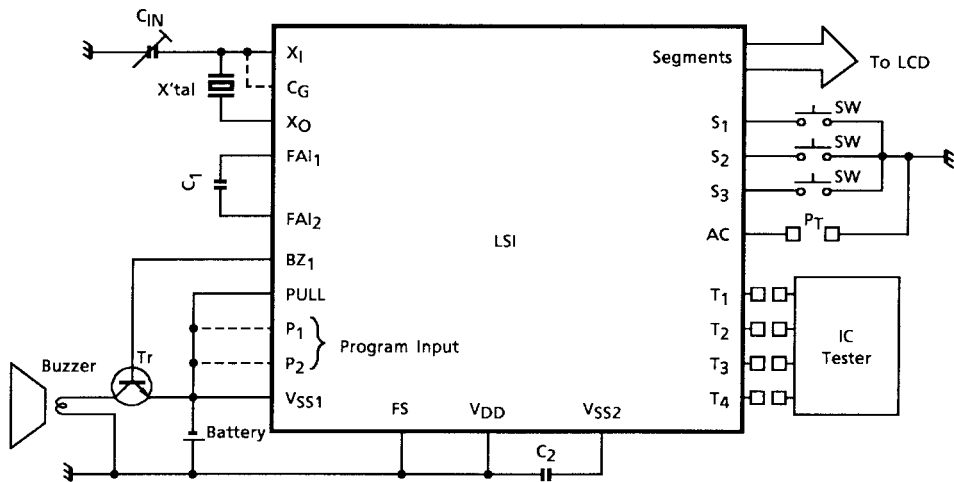
X'tal: $R_S = 30 \text{ k}\Omega$ (max)

(4)



Application Circuit Example

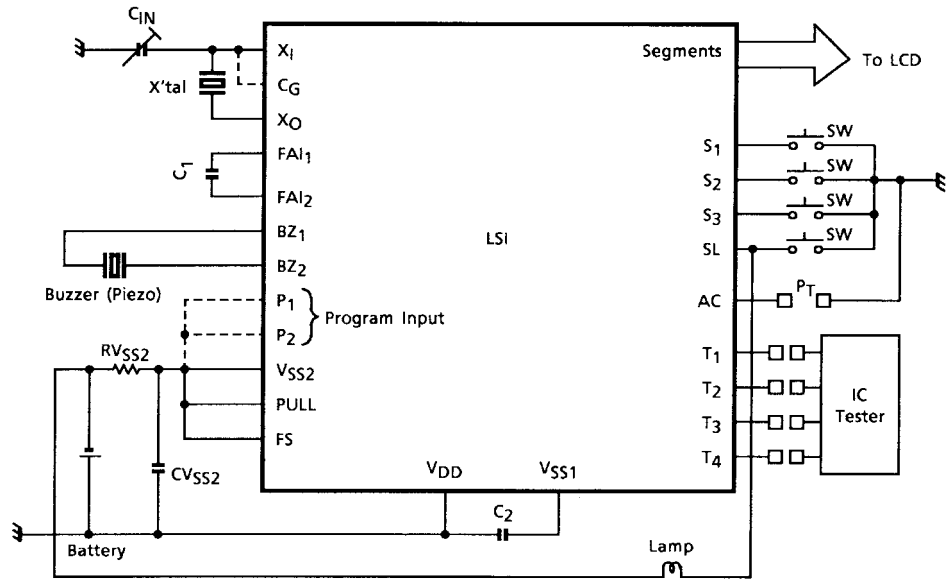
Silver Oxide Type (–1.55 V)



- Note 17: For specifications featuring an alarm, add a transistor and buzzer.
- Note 18: The FS pin is a bonding option. With silver oxide-type circuits, connect to the VDD.

Symbol	Supplementary Description	Value	Unit
C _{IN}	Oscillator stage gate capacitance (variable)	5-33	pF
C _{OUT}	Oscillator stage trend capacitance (built in)	16 (typ.)	pF
C ₁	Voltage doubler/halver circuit capacitance	0.1	μF
C ₂	Voltage doubler/halver circuit capacitance	0.1	μF
Battery	Single power supply	1.55 (typ.)	V
X'tal	f ₀ = 32.768 kHz, R _S = 30 kΩ (max)	—	—
SW	Push-switch (SPST)	—	—
Tr	Buzzer drive transistor (NPN)	—	—
Buzzer	Magnet buzzer	≈ 4	kHz
P _T	Manual reset pin	—	—

Lithium Type (–3.0 V)



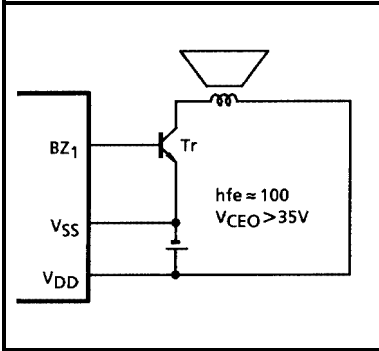
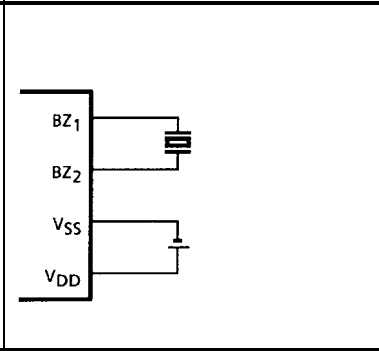
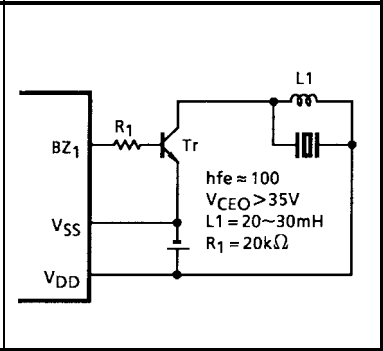
Note 19: For specifications featuring an alarm, add a transistor and buzzer.

Note 20: The FS pin is a bonding option. With lithium-type circuits, connect to VSS2.

Note 21: To ensure that the system starts up normally, turn on the SL switch before you actually start up the system after setting the battery in place.

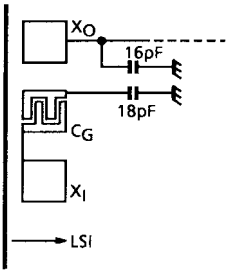
Symbol	Supplementary Description	Value	Unit
C _{IN}	Oscillator stage gate capacitance (variable)	5-33	pF
C _{OUT}	Oscillator stage trend capacitance (built in)	16 (typ.)	pF
C ₁	Voltage doubler/halver circuit capacitance	0.1	μF
C ₂	Voltage doubler/halver circuit capacitance	0.1	μF
X'tal	f _o = 32.768 kHz, R _S = 30 kΩ (max)	—	—
SW	Push-switch (SPST)	—	—
Tr	Buzzer drive transistor (NPN)	—	—
P _T	Manual reset pin	—	—
Battery	Internal resistance (–20°C)	50 (max)	Ω
Lamp	Resistance when –3.0 V-drive	500 (min)	Ω
RVSS2	Voltage smoothing resistor	1	kΩ
CVSS2	Voltage smoothing capacitance	0.1 (min)	μF
Buzzer	Magnet buzzer or piezo buzzer f _o = 4 kHz	4	kHz

Buzzer Drive Application Circuit

SP	PIEZO	PIEZO (Tr drive)
		

C_G Pin (bonding option)

If the C_G Pin is bonded instead of the X_I Pin, the built-in capacitance (18 pF) is connected.



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